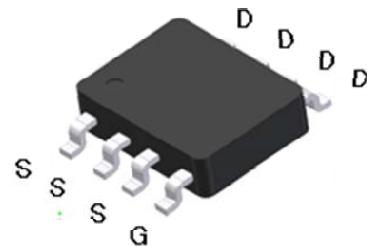
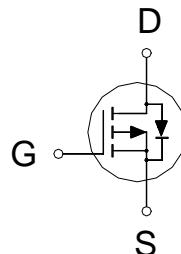


**P-Channel Logic Level Enhancement Mode Field Effect Transistor**
**Product Summary:**

$BV_{DSS}$	-30V
$R_{DS(on)}$ (MAX.)	20m $\Omega$
$I_D$	-10A

UIS,  $R_g$  100% Tested

Pb-Free Lead Plating &amp; Halogen Free


**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		$V_{GS}$	$\pm 25$	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	-10	A
	$T_C = 100^\circ\text{C}$		-8	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-40	
Avalanche Current		$I_{AS}$	-15	
Avalanche Energy	$L = 0.1\text{mH}, I_D = -10\text{A}, R_G = 25\Omega$	$E_{AS}$	5	mJ
Repetitive Avalanche Energy <sup>2</sup>	$L = 0.05\text{mH}$	$E_{AR}$	2.5	
Power Dissipation	$T_A = 25^\circ\text{C}$	$P_D$	2.5	W
	$T_A = 100^\circ\text{C}$		1	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	°C

100% UIS testing in condition of  $V_D = -15\text{V}$ ,  $L = 0.1\text{mH}$ ,  $V_G = -10\text{V}$ ,  $I_L = -10\text{A}$ , Rated  $V_{DS} = -30\text{V}$  P-CH
**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$	25	50	°C / W
Junction-to-Ambient <sup>3</sup>	$R_{\theta JA}$			

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>Duty cycle ≤ 1%<sup>3</sup>50°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1	-1.5	-3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 100$	nA
		$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 25\text{V}$			$\pm 500$	
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
		$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			-10	
On-State Drain Current <sup>1</sup>	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = -5\text{V}, V_{\text{GS}} = -10\text{V}$	-10			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = -10\text{V}, I_D = -10\text{A}$		17.5	20	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -7\text{A}$		26	35	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = -5\text{V}, I_D = -10\text{A}$		24		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -15\text{V}, f = 1\text{MHz}$		1407		
Output Capacitance	$C_{\text{oss}}$			208		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			164		
Gate Resistance	$R_g$	$V_{\text{GS}} = 15\text{mV}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		4.5		$\Omega$
Total Gate Charge <sup>1,2</sup>	$Q_g(V_{\text{GS}}=10\text{V})$	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -10\text{V}, I_D = -10\text{A}$		20.3		nC
	$Q_g(V_{\text{GS}}=4.5\text{V})$			9.8		
Gate-Source Charge <sup>1,2</sup>	$Q_{\text{gs}}$			3.2		
Gate-Drain Charge <sup>1,2</sup>	$Q_{\text{gd}}$			4.9		
Turn-On Delay Time <sup>1,2</sup>	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = -15\text{V}, I_D = -1\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GS}} = 2.7\Omega$		10		nS
Rise Time <sup>1,2</sup>	$t_r$			8		
Turn-Off Delay Time <sup>1,2</sup>	$t_{\text{d}(\text{off})}$			25		
Fall Time <sup>1,2</sup>	$t_f$			6		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$	$I_F = I_S, V_{\text{GS}} = 0\text{V}$			-3	A
Pulsed Current <sup>3</sup>	$I_{\text{SM}}$				-12	
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$				-1.2	
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = I_S, dI_F/dt = 100\text{A} / \mu\text{s}$		32		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			26		

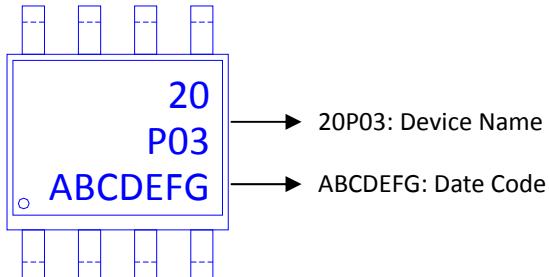
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\mu$  sec, Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

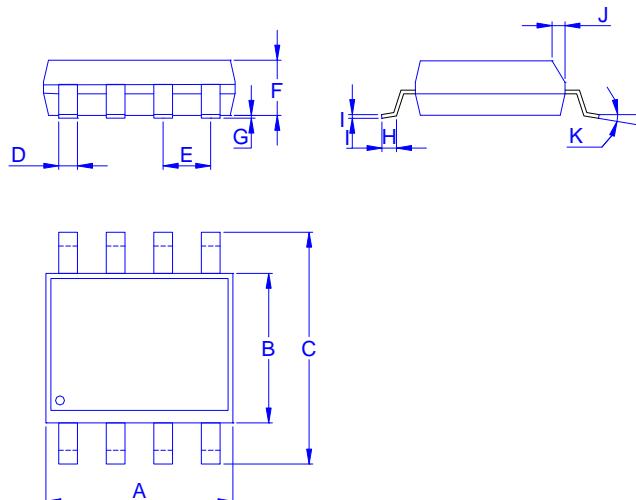
<sup>3</sup>Pulse width limited by maximum junction

Ordering & Marking Information:  
temperature.

Device Name: LB20P03H for SOP-8



### Outline Drawing



Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K
in.	4.70	3.70	5.80	0.33		1.20	0.08	0.40	0.19	0.25	0°
Typ.					1.27						
Max.	5.10	4.10	6.20	0.51		1.62	0.28	0.83	0.26	0.50	8°

